

**IPC/JEDEC J-STD-020E**

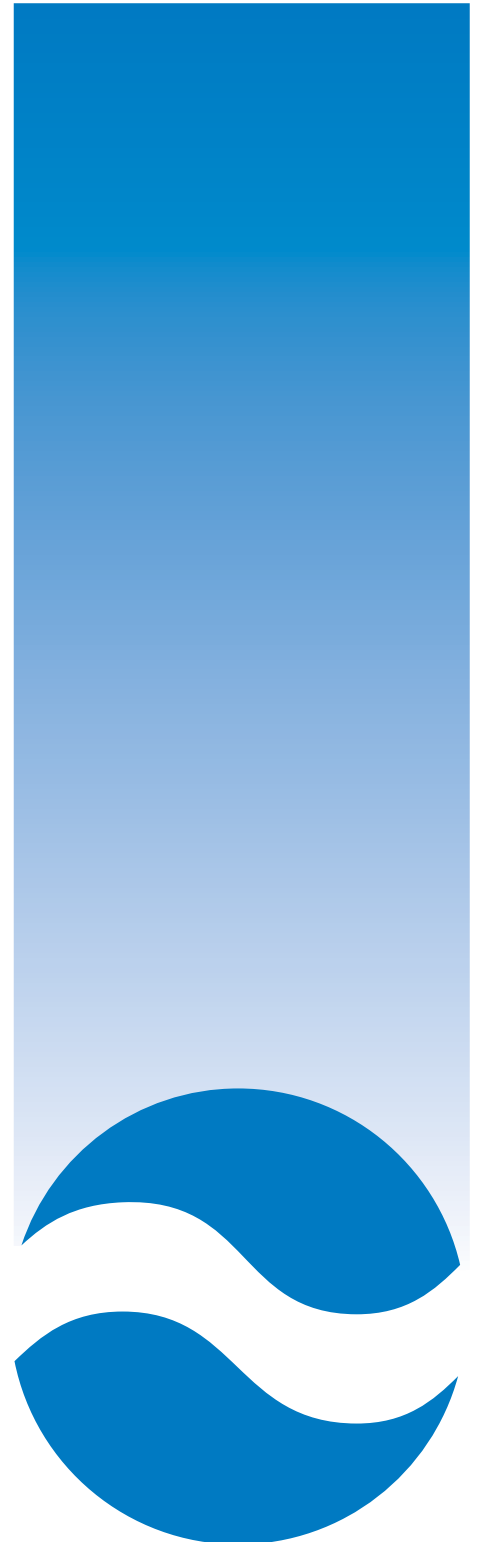
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March 2008

# ***JOINT INDUSTRY STANDARD***

Moisture/Reflow  
Sensitivity Classification  
for Nonhermetic Surface  
Mount Devices



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*For Technical Information Contact:*

**JEDEC**  
**Solid State Technology Association**  
3103 North 10th Street, Suite 240-S  
Arlington, VA 22201-2107  
Tel 703 907.0026  
Fax 703 907.7501

**IPC**  
3000 Lakeside Drive, Suite 309S  
Bannockburn, Illinois  
60015-1249  
Tel 847 615.7100  
Fax 847 615.7105

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IPC/JEDEC J-STD-020E

# Moisture/Reflow Sensitivity Classification for Nonhermetic Surface Mount Devices

A joint standard developed by the IPC Plastic Chip Carrier Cracking Task Group (B-10a) and the JEDEC JC-14.1 Committee on Reliability Test Methods for Packaged Devices

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IPC/JEDEC J-STD-020B -  
July 2002  
IPC/JEDEC J-STD-020A -  
April 1999  
J-STD-020 - October 1996  
JEDEC JESD22-A112  
IPC-SM-786A - January 1995  
IPC-SM-786 - December 1990

Users of this standard are encouraged to participate in the development of future revisions.

Contact:

**JEDEC**  
**Solid State Technology Association**  
3103 North 10th Street, Suite 240-S  
Arlington, VA 22201-2107  
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